

# NING BO RHT ELECTR ONIC CO.,LTD

# APPROVAL SHEET



# (Seam Type)

CUSTOMER:	
DESCRIPTION:	SMD3225 25.000MHz Quartz Crystal Resonator
MANUFACTURER PART NO.:	25.000M18SM3S-20/30DFC47
CUSTOMER PART NO:	
USED IN MODEL:	
REVISION	A1

APPROVAL				
TECHNOLOGY DEPT.	QUALITY DEPT.	PURCHASING DEPT.		

Rev	Revise page	Revise contents	<u>Date</u>	Ref.No.	Reviser
A1	ALL	Initial released	2022.11.11	N/A	DavidJiang

NINGBO RHT ELECTRONIC CO.,LTD				
DESCRIPTION	SMD3225 25.000MHz ±20ppm 18pF	Page:		
DATE	2022-11-11	2 / 12		

## 1. QUARTZ CRYSTAL UNIT SPECIFICATION

Parameter	Sign	Specification
1.1 Nominal Frequency :	F0	25.000MHz
1.2 Holder type :	-	(SMD3225 SEAM TYPE)
1.3 Mode of oscillation :	-	Fundamental
1.4 Frequency tolerance :	FL	±20ppm at 25℃±3℃
1.5 Equivalent resistance :	RR	40ohms max.
1.6 Operating temperature range :	Topr	-40℃ To +85℃
1.7 Storage temperature range :	T <sub>STG</sub>	-55℃ To +125℃
1.8 Frequency Stability :	TC	±30ppm at -40℃ To +85℃
1.9 Loading capacitance :	CL	18pF
1.10 Drive level :	DL	10 uW Typical. 200uW Max
1.11 Shunt Capacitance :	C0	2.0pF max.
1.12 Insulation resistance :	IR	More than $500 \text{M}\Omega$ at DC $100 \text{V}$
1.13 Circuit:	-	Measured in HP/E5100A,S&A 250B
1.14 Aging :	Fa	±3ppm max. (+25℃ 1 <sup>st</sup> Year)
1.15 Dimensions and marking :		Refer to page.3
1.16 Emboss carrier tape & reel :		Refer to page.5 and page.6

#### 1.17 Note:

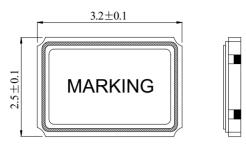
#### Standard atmospheric conditions

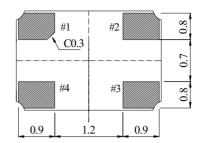
Unless otherwise specified, the standard range of atmospheric conditions for making measurement and tests are as follow:

Ambient temperature :  $25\pm3^{\circ}$ C Relative humidity : 40%~70%

	NINGBO RHT ELECTRONIC CO.,LTD	
DESCRIPTION	SMD3225 25.000MHz ±20ppm 18pF	Page:
DATE	2022-11-11	3 / 12

## 2. MARKING & DIMENSIONS

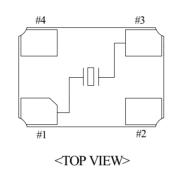


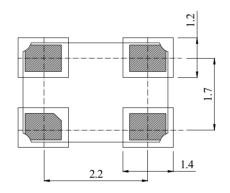




Marking #2, #4 is connected with metal cap of top.

(UNIT: mm)





Recommended Solder Pad Layout:

\*Marking should be printed as following:

Logo, Nominal Frequency

\*Manufacturing Logo: RHT

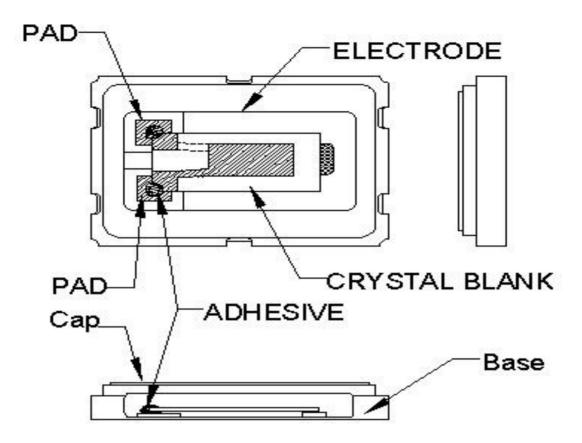
\*Nominal frequency = 3 number after decimal point MAX.

(ex. 25.000 MHz  $\rightarrow$  25.000)

Marking: Laser marking

	NINGBO RHT ELECTRONIC CO.,LTD	
DESCRIPTION	SMD3225 25.000MHz ±20ppm 18pF	Page:
DATE	2022-11-11	4 / 12

# 3. INSIDE STRUCTURE



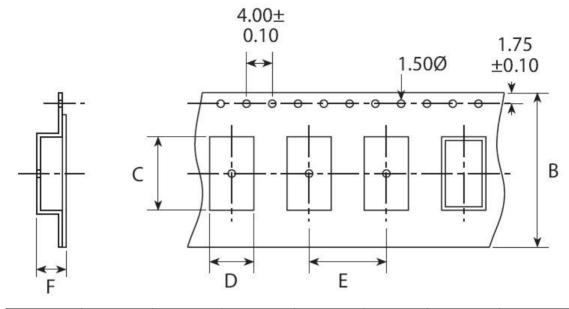
#### Reference drawing

Telefolioc drawing	
Base:	
Alumina Ceramic (Al <sub>2</sub> O <sub>3</sub> )	
Metallized Pad: W	
Ni Plating	
Au Plating	
Cap:	
Fe-Ni	
(3) Crystal Enclosure Seal:	
Seal Seam	
(4) Crystal Blank	
Rectangular At-Cut Quartz Crystal Blank	
(5) Adhesive	
Silver Conductive Polyimide Resin	
(6) Electrode	
Ag	
(7) PAD	
Alumina Ceramic (W. Ni. Au)	

NINGBO RHT ELECTRONIC CO.,LTD				
DESCRIPTION	SMD3225 25.000MHz ±20ppm 18pF	Page:		
DATE	2022-11-11	5 / 12		

## 4. EMBOSS CARRIER TAPE & REEL

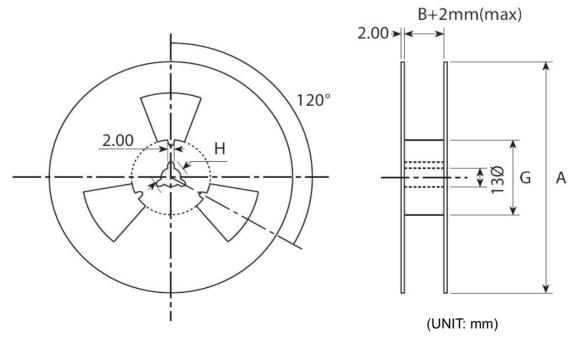
## a.) Dimensions of Carrier Tape



	A	В	С	D	Е	F	G
SMD3225	$178 \pm 2.0$	$8.0 \pm 0.3$	3.5±0.1	$2.8 \pm 0.1$	4.0±0.1	1.4±0.1	$60.5 \pm 1.0$

(UNIT: mm)

## b.) Dimensions of Reel



NINGBO RHT ELECTRONIC CO.,LTD				
DESCRIPTION	SMD3225 25.000MHz ±20ppm 18pF	Page:		
DATE	2022-11-11	6 / 12		

c.) Storage condition

Temperature: +40deg.C Max. Relative Humidity: 80% Max.

d.) Standard packing quantity

3,000PCS / REEL

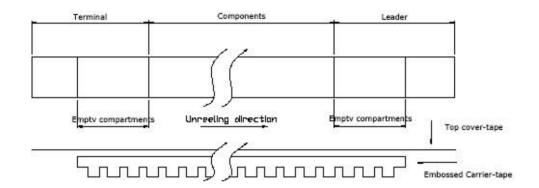
e.) Material of the tape

Tape	Material
Carrier tape	A – PET
Top tape	Polyester

NINGBO RHT ELECTRONIC CO.,LTD			
DESCRIPTION	SMD3225 25.000MHz ±20ppm 18pF	Page:	
DATE	2022-11-11	7 / 12	

#### g.) Taping dimension

Leader	Cover-tape	The length of cover-tape in the leader is more than 400 mm including empty embossed area.
	Carrier-tape	After all products were packaged, must remain more than twenty pieces or 400 mm empty area, which should be sealed by cover-tape.
Terminal	Cover-tape	The tip of cover-tape shall be fixed temporary by paper tape and roll around the core of reel one round.
	Carrier-tape	The empty embossed area which are sealed by top cover-tape must remain more the 40 mm.



#### h.) Joint of tape

The carrier-tape and top cover-tape should not be jointed.

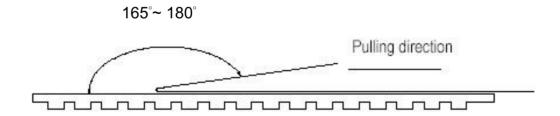
i.) Release strength of cover tape

It has to between 0.1N to 0.7N under following condition.

Pulling direction 165° to 180°

Speed 300mm/min.

Otherwise unless specified.

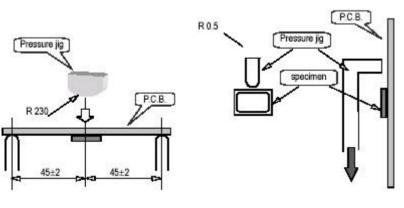


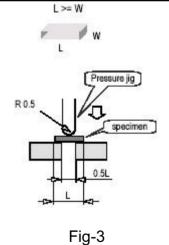
Other standards shall be based on JIS C 0806-1990.

NINGBO RHT ELECTRONIC CO.,LTD		
DESCRIPTION         SMD3225 25.000MHz ±20ppm 18pF         Page:		Page:
DATE	2022-11-11	8 / 12

5. Mechanical Endurance: Provided that measurement shall be carried out afterletting it alone in the room temperature for 1 hour.

	Item	Conditions	Specifications
5.1	Drop	Fall freely from 100 cm of height 3 times on a firm wood	MIL-STD-202F-203B
5.2	Mechanical Shock	Device are shocked to half sine wave (1000 G) three mutually perpendicular axes each 3 times.	MIL-STD-202F
5.3	Vibration	<ul> <li>(1)Vibration Frequency: 10~55Hz</li> <li>(2)Cycle: 1 to 2 Min.</li> <li>(3)Full Cycle: 1.5mm P-P.</li> <li>(4)Direction: X.Y.Z</li> <li>(5)Time: 2 Hours / Each Direction</li> </ul>	MIL-STD-883E
5.4	Substrate Bending	Mount the specimen on substrate.  Apply the following pressure  Direction: see Fig –1  Speed: 0.5 mm/sec  Hours: 5 ± 1 sec  Amount of substrate: 3 mm Max.	Without mechanical
5.5	Adhesion	Mount the specimen on substrate.  Apply the following pressure  Direction: see Fig –2  Weight: 10N  Hours: 10 ± 1 sec	damage such as breaks.  Without electrode peeling.  Electrical characteristics shall be satisfied.
5.6	Body strength	Mount the specimen on substrate.  Apply the following pressure  Direction: see Fig –3  Weight: 10N  Hours: 10 ± 1 sec	
5.7	Seal	Fine Leak: 4.5kgf/cm <sup>2</sup> 2hours 1×10 <sup>-9</sup> Pa.m <sup>3</sup> /sec Gross Leak: 4.5kgf/cm <sup>2</sup> 2hours 1.5×10 <sup>-5</sup> Pa.m <sup>3</sup> /sec	MIL-STD-883E





Fig_1	Fig_2
Fig-1	Fig-2

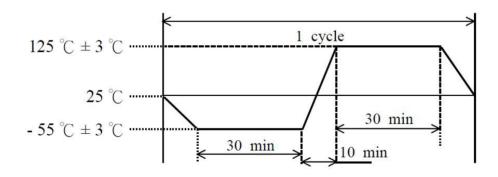
NINGBO RHT ELECTRONIC CO.,LTD		
DESCRIPTION	SMD3225 25.000MHz ±20ppm 18pF	Page:
DATE	2022-11-11	9 / 12

5.8	Solder ability	Pre-heat temperature: +150±10°C Pre-heat time: 60~120s When the temperature of the specimen is reached at +215±3°C, it shall be left for 30±1sec. Peak temperature 240±5°C Material: Pb-free (Sn-3.0Ag-0.5Cu) Flux: Rosin resin methyl alcohol solvent (1:4) The electrodes should be covered by a new solder at least 90% of immersed area.	MIL-STD-883E 2003
5.9	Resistance to Soldering Heat	Run in Reflow Reflow soldering shall be allowed Only two(2) time.  Available for Lead Free Soldering  PEAK 260±5°C 10s  TIME (Seconds) Total:  (1) Preheat 160~180 deg.C 120sec. (2) Primary heat 220 deg.C 60sec. (3) Peak 260 deg.C 10sec. Max.	MIL-STD-202F

NINGBO RHT ELECTRONIC CO.,LTD			
DESCRIPTION	SMD3225 25.000MHz ±20ppm 18pF	Page:	
DATE	2022-11-11	10 / 12	

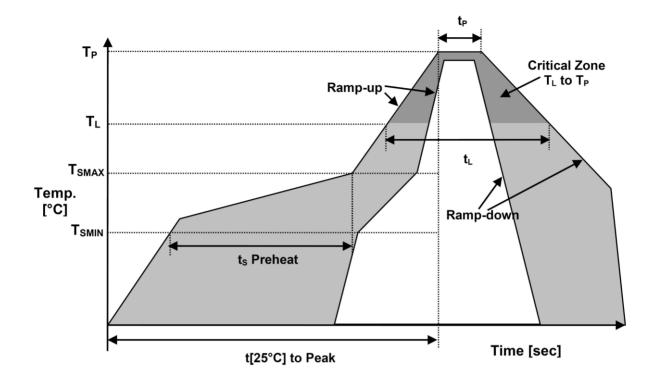
6. Environmental Endurance: Provided that measurement shall be carried out afterletting it alone in the room temperature for 1 hour.

	Item	Conditions	Specifications
6.1	Humidity	+60℃±2℃,RH 80~85%, Duration of 500 hours.  The units are then allowed to stand for approx 2 hours in room temperature before checking	MIL-STD-202F
6.2	Storage in Low Temperature	Temperature: -40±2 $^{\circ}$ C , Duration of 500 hours. The units are then allowed to stand at room temperature for approx 2 hours before checking.	MIL-STD-883E
6.3	Storage in High Temperature	Temperature:+85℃±2℃, Duration of 500 hours. The units are then allowed to stand at room temperature for approx 2 hours before checking.	MIL-STD-883E
6.4	Thermal Shock	Temperature 1: -55°C±5°C  Temperature 2: 125°C±5°C  Temperature change between T1 and T2 at soonest  Run 100 cycles, maintain T1 and T2 30minutes each in one cycle  (Refer to Fig-4)	MIL-STD-883E



NINGBO RHT ELECTRONIC CO.,LTD		
DESCRIPTION	SMD3225 25.000MHz ±20ppm 18pF	Page:
DATE	2022-11-11	11 / 12

# 7. Recommended Solder Reflow Profile



Temperature Min Preheat	T <sub>SMIN</sub>	150℃
Temperature Max Preheat	T <sub>SMAX</sub>	175℃
Time (T <sub>SMIN</sub> to T <sub>SMAX</sub> )	ts	60-180 sec.
Temperature	TL	217℃
Peak Temperature	T <sub>P</sub>	260℃
Ramp-up rate	Rup	3℃/sec max.
Ramp-down rate	R <sub>DOWN</sub>	6℃/sec max.
Time within 5°C of Peak Temperature	t <sub>P</sub>	10 sec max.
Time t[25°C] to Peak Temperature	t[25°C] to Peak	480 sec max.
Time	t <sub>L</sub>	60-150 sec.

NINGBO RHT ELECTRONIC CO.,LTD			
DESCRIPTION	SMD3225 25.000MHz ±20ppm 18pF	Page:	
DATE	2022-11-11	12 / 12	